

NEW

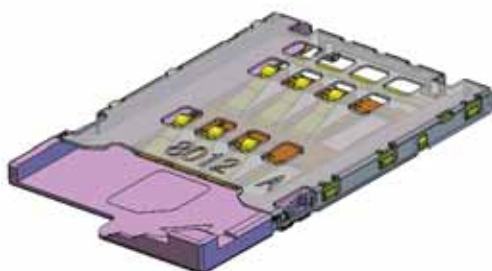
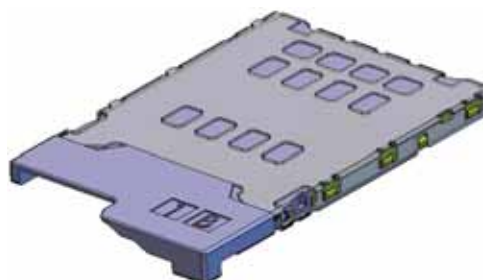
 PLUG IN SIM Card Connector
 compatible to GSM 11.11 Standard

CONNECTOR

MB-0194-1

January 2009

SF8 Series

RoHS Compliant

Standard

Reverse

SF8 Series is a tray type connector compatible with GSM 11.11 standard Plug in SIM card for GSM mobile phones.

(SIM: Subscriber Identification Module)

Features

- Tray type connector for GSM 11.11 standard Plug in SIM card
- Low profile structure, 1.55mm height, 16.65mm width, 19.3mm depth (26.2mm when card is inserted).
- Two types of mounting, normal (A type) and reverse (B type).
- Connector main body is provided in emboss (compatible to second reflow), tray provided in tray (tray is attached after mounting the main body).
- 4 portions of H/D ensures EMI/ESD countermeasure and gives consideration to prevention of instantaneous interruption caused by falling.
- Retention lock on tray provides click feeling when mated, and makes positioning easier and also prevents falling of tray.

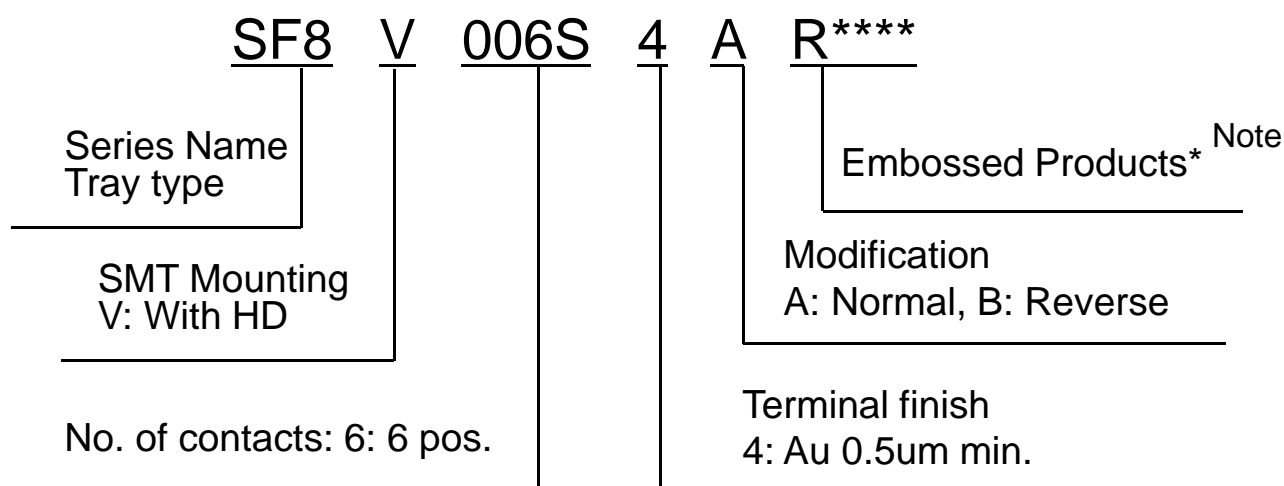
General Specification

- | | |
|------------------------------------|-----------------------------|
| •No. of Contacts: 6pos. | •Rated Current: 10u A to 1A |
| •Contact Resistance: 100m ohm max. | •Insulation Resistance: |
| •Dielectric Withstanding Voltage: | 1000M ohm min. |
| AC500Vr.m.s 1minute | •Lifetime: 5000 times |
| •Operating Temperature: | |
| -40 Deg. C to +90 Deg. C | |

Materials and Finishes

Component	Material/Finish
Contact	Copper alloy/0.5u min. Au over Ni (contact area)
Housing	Glass filled LCP/none(UL94V-0)
Cover Frame	Stainless steel/none, Au plating over Ni (terminal portion only)
Tray	POM/none (UL94HB)

Ordering Information



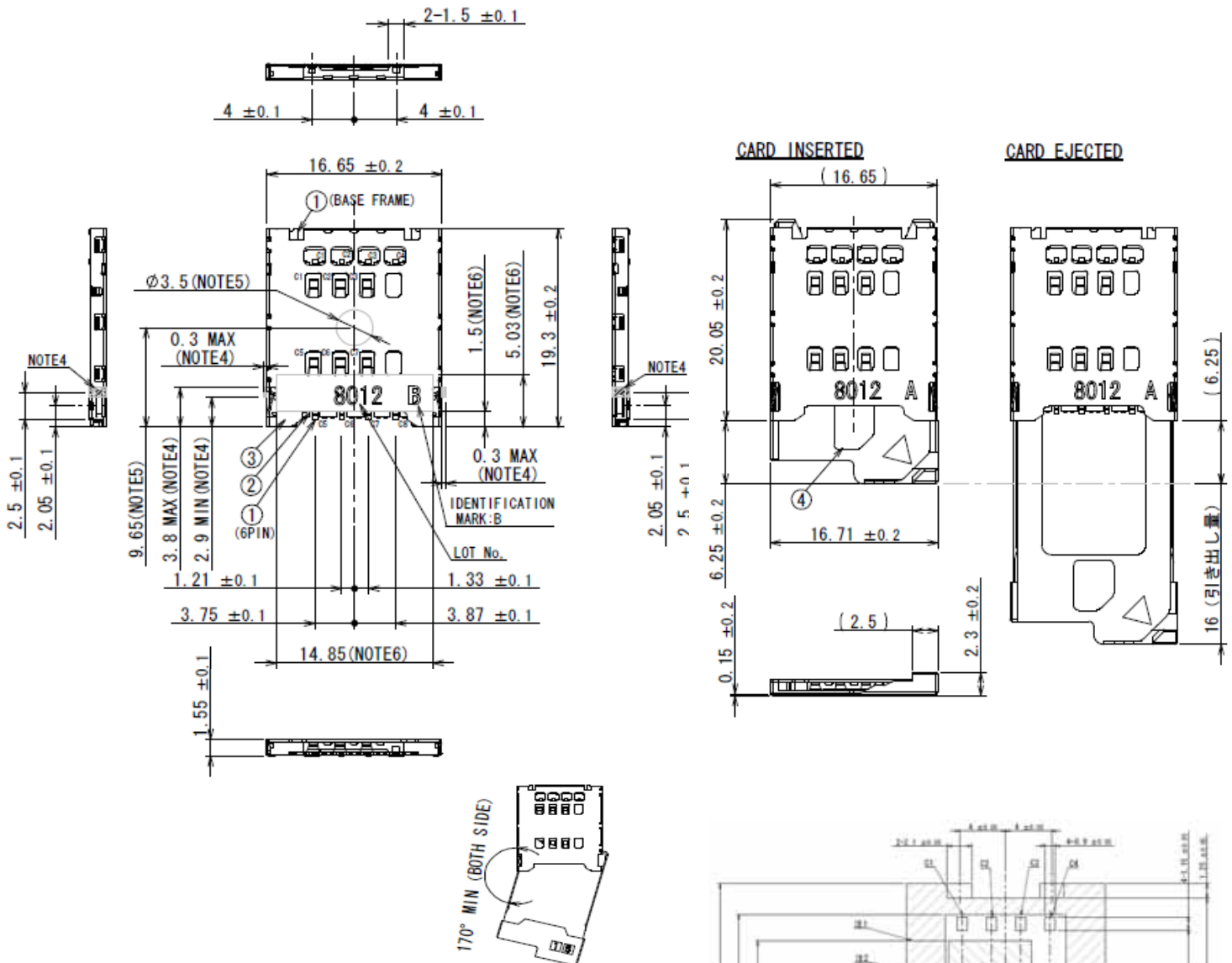
Note) Main body of connector is supplied in emboss, tray in tray packaging.
Please contact us for further information.

Please refer to JAHL-10578 for assembly and handling of connector and tray.

Part Number	SJ Drawing
SF8V006S4A (main body of connector)	SJ109314
SF8-ST51-A (Type A tray)	SJ109315

Standard
Mounting Type

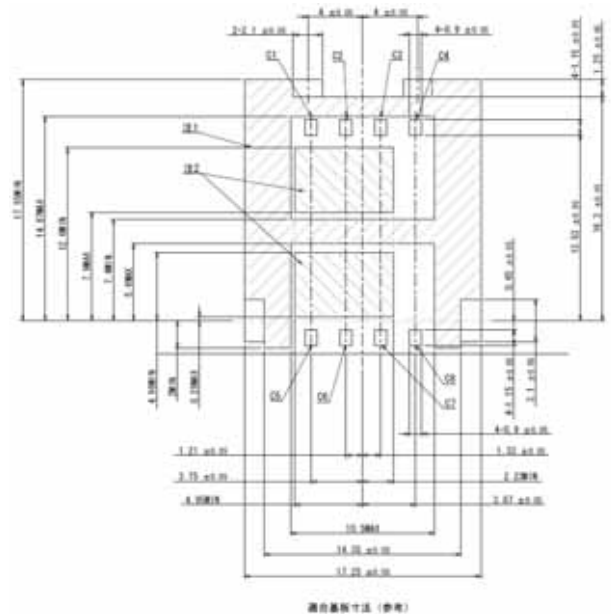
Unit: mm



LOCATE THE PARTS (CASE)
170° MIN.
170° 以上になるように
筐体設定願います。

- NOTE1. NO PATTERN AND VIA HOLE SHOULD BE LOCATED IN THIS AREAS. BUT PATTERN OF GND IS APPROVAL
- NOTE2. NO PATTERN AND VIA HOLE SHOULD BE LOCATED IN THIS AREAS.
- NOTE3. NO PATTERN, VIA HOLE AND SOLDER RESIST IN THIS AREAS.
- NOTE4. NO PARTS LOCATED IN THIS AREA.
- NOTE5. VACUUM AREA
- NOTE6. LOT No. & IDENTIFICATION MARK AREA
- NOTE7. COPLANARITY SHOULD BE 0.1mmMAX.
- NOTE8. THE THICKNESS OF REINFORCEMENT BOARD IS 0.6MIN. WHEN THE PRODUCT WILL MOUNT ON FPC.

- 注1. パターン及びビアホール禁止エリアを示す。但し、GNDのパターンは可とする
- 注2. パターン及びビアホール禁止エリアを示す。
- 注3. パターン、ビアホール及びレジスト禁止エリアを示す。
- 注4. 部品搭載不可エリアを示す。
- 注5. 吸着エリア
- 注6. LOT No. 及び識別マークエリア (本品 : B)
- 注7. コプラナリティー0.1mm以下とする。
- 注8. FPC搭載時の補強板厚は0.6以上とする。



APPLICABLE P. C. B. DIMENSION (REF)

